



SPECIFICATION

(Reference sheet)

• Supplier : Samsung electro-mechanics • Samsung P/N : CL03B103KQ3NNND

• Product : Multi-layer Ceramic Capacitor • Description : CAP, 10nF, 6.3V, ±10%, X7R, 0201

A. Samsung Part Number

<u>CL</u> <u>03</u> <u>B</u> <u>103</u> <u>K</u> <u>Q</u> <u>3</u> <u>N</u> <u>N</u> <u>N</u> <u>D</u> ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

1	Series	Samsung Multi-layer Ceramic Capacitor		
2	Size	0201 (inch code)	L: 0.6 ± 0.03 mm	W: 0.3 ± 0.03 mm
3	Dielectric	X7R	Inner electrode	Ni
4	Capacitance	10 nF	Termination	Cu
⑤	Capacitance	±10 %	Plating	Sn 100% (Pb Free)
	tolerance		9 Product	Normal
6	Rated Voltage	6.3 V	10 Special	Reserved for future use
7	Thickness	$0.3 \pm 0.03 \text{ mm}$	Packaging	Cardboard Type, 13" reel

B. Samsung Reliability Test and Judgement condition

	Performance	Test condition		
Capacitance	Within specified tolerance	1klb±10% 1.0±0.2Vrms		
Tan δ (DF)	0.05 max.			
Insulation 10,000Mohm or 100Mohm⋅μF		Rated Voltage 60~120 sec.		
Resistance	Whichever is Smaller			
Appearance	No abnormal exterior appearance	Microscope (×10)		
Withstanding	No dielectric breakdown or	250% of the rated voltage		
Voltage	mechanical breakdown			
Temperature	X7R			
Characteristics	(From -55 ℃ to 125 ℃, Capacitance change should be within ±15%)			
Adhesive Strength	No peeling shall be occur on the	200g·F, for 10±1 sec.		
of Termination	terminal electrode			
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm)		
		with 1.0mm/sec.		
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder		
	is to be soldered newly	245±5℃, 3±0.3sec.		
		(preheating : 80~120 ℃ for 10~30sec.)		
Resistance to	Capacitance change: within ±7.5%	Solder pot : 270±5℃, 10±1sec.		
Soldering heat	Tan δ, IR : initial spec.			

	Performance	Test condition
Vibration Test	Capacitance change: within ±5°	% Amplitude : 1.5mm
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)
		2hours × 3 direction (x, y, z)
Moisture	Capacitance change: within ±12	2.5% With rated voltage
Resistance	Tan δ: 0.075 max	40±2℃, 90~95%RH, 500+12/-0hrs
	IR: 25MΩ·μF or Over	
High Temperature	Capacitance change : within ±12	2.5% With 200% of the rated voltage
Resistance	Tan δ: 0.075 max	Max. operating temperature
	IR: 50MΩ·μF or Over	
		1000+48/-0hrs
Temperature	Capacitance change: within ±7.	5% 1 cycle condition
Cycling	Tan δ, IR : initial spec.	Min. operating temperature → 25 °C
		→ Max. operating temperature → 25°C
		5 cycle test

C. Recommended Soldering method:

Reflow (Reflow Peak Temperature : 260+0/-5°C, 10sec. Max)



Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.